

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

are listed below) of	f the subject matter which is claimed a	and for which a patent is sought on the SYSTEM, ELECTRON	invention entitled
	DEV	VICE AND METHOD	
the specification of	which X is attached hereto	was filed on	as United States Application
No. or PCT Interna	tional Application No.		
and was amended t			(ii applicable).
I hereby sta by any amendment	ate that I have reviewed and understand referred to above.	d the contents of the above-identified s	pecification, including the claims, as amended
I acknowle	edge the duty to disclose information v	which is material to patentability as de	fined in 37 CFR §1.56.
certificate, or § 365 have also identified	aim foreign priority benefits under 35 (a) of any PCT international application below any foreign application for pate ion on which priority is claimed:	U.S.C. §119(a)-(d) or §365(b), of any on which designates at least one country or inventor's certificate, or PCT inter	foreign application(s) for patent or inventor's y other than the United States, listed below and national application having a filing date before
Country	Application No.	Filed (Day/Mo./Yr.)	(Yes/No) Priority Claimed
Japan	11-218081	July 30, 1999	Yes
Japan Japan	2000-219334	July 19, 2000	Yes
designating the Uni United States or Podisclose information	aim the benefit under 35 U.S.C. § 120 ited States, listed below and, insofar as CT international application in the main which is material to patentability as 6 and in the patentability	the subject matter of each of the claims inner provided by the first paragraph of lefined in 37 C.F.R. § 1.56 which becar	§ 365(c) of any PCT international application of this application is not disclosed in the prior of 35 U.S.C. § 112, I acknowledge the duty to ne available between the filing date of the prior
	Amplication No	Filed (Day/Mo./Yr.)	Status
belief are believed made are punishab statements may jeo	eclare that all statements made herein to be true; and further that these state le by fine or imprisonment, or both, u spardize the validity of the application	ments were made with the knowledge nder Section 1001 of Title 18 of the U or any patent issued thereon.	at all statements made on information and that willful false statements and the like so inited States Code and that such willful false
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co	ED DECLARATION AND POWER OF ATTORN FOR PATENT APPLICATION	
	(Page 2)	

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